	Type	Hits	Search Text	DBs
1	BRS	639	257/797	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
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12	BRS	0	(interposer or interconnet$3 or redistribut$3) and mark	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
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	Type	Hits	Search Text	DBs
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15	BRS	408	(interposer or interconnet$3 or redistribut$3)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
16	BRS	16858	(interposer or interconnet$3 or redistribut$3)	USPAT; JPO
17	BRS	7815	(interposer or interconnet$3 or redistribut$3) and (mark or code or align$5)	USPAT; JPO
18	BRS	1102	(interposer or interconnet$3 or redistribut$3) same (mark or code or align$5)	USPAT; JPO
19	BRS	550	(interposer or interconnet$3 or redistribut$3) same (mark or code or align$5) and (semiconductor or chip or die or IC)	USPAT; JPO
20	BRS	303	(interposer or interconnet$3 or redistribut$3) with (mark or code or align$5) and (semiconductor or chip or die or IC)	USPAT; JPO
21	BRS	56	(interposer or interconnet$3 or redistribut$3) with (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC)	USPAT; JPO

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23	BRS	9	(interposer or interconnet$3 or redistribut$3) same (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC) not ((interposer or interconnet$3 or redistribut$3) with (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC))	US-PGPUB; EPO
24	BRS	2	(interposer or interconnet$3 or redistribut$3) same (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC) not ((interposer or interconnet$3 or redistribut$3) with (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC))	DERWENT; IBM_TDB
25	BRS	1	"5969426"	DERWENT; IBM_TDB
26	BRS	8	"5969426"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB

	Type	Hits	Search Text	DBs
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28	BRS	447	(dic$3 or scrib$3) near (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
29	BRS	158	257/786 and (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
30	BRS	86	257/786 and (interconnect$3 or redistribut$3 or interposer) and (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
31	BRS	6	257/786 and (interconnect$3 or redistribut$3 or interposer) same (mark or code or align$5 near (mark or code)) and (semiconductor or chip or die or IC)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
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34	BRS	8	5354955.pn. or 5583321.pn. or 6043670.pn.	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
35	BRS	30	"5438223"	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
36	BRS	8	"5438223" and (mark or code)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
37	BRS	7	"5438223" and (mark or code) and (interconnect$3 or redistribut$3 or interposer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
38	BRS	0	"5438223" and (mark or code) near (interconnect$3 or redistribut$3 or interposer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
39	BRS	0	(5858815.pn. or 5879964.pn. or 6181569.pn. or 6353328.pn.) and (mark or code) near (interconnect$3 or redistribut$3 or interposer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
40	BRS	0	"5939132" and (mark or code) near (interconnect$3 or redistribut$3 or interposer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
41	BRS	0	"6137161" and (mark or code) near (interconnect$3 or redistribut$3 or interposer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB
42	BRS	0	"6081030" and (mark or code) near (interconnect$3 or redistribut$3 or interposer)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB